

HIGH VOLTAGE FASTSWITCHING NPN POWER TRANSISTOR

- SGS-THOMSON PREFERRED SALESTYPES
- HIGH VOLTAGE CAPABILITY
- VERY HIGH SWITCHING SPEED
- LOW BASE-DRIVE REQUIREMENTS

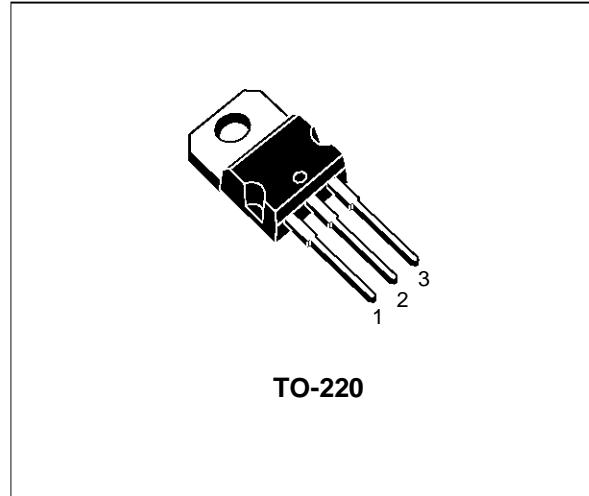
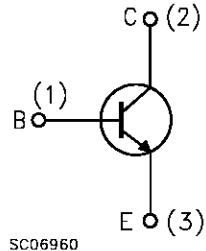
APPLICATIONS:

- SWITCH MODE POWER SUPPLIES
- HORIZONTAL DEFLECTION FOR COLOUR TVs AND MONITORS

DESCRIPTION

The SGSF344 is manufactured using Multiepitaxial Mesa technology for cost-effective high performance and uses a Hollow Emitter structure to enhance switching speeds.

The SGSF series is designed for high speed switching applications such as power supplies and horizontal deflection circuits in TVs and monitors.


INTERNAL SCHEMATIC DIAGRAM

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage ($V_{BE} = 0$)	1200	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	600	V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	7	V
I_C	Collector Current	7	A
I_{CM}	Collector Peak Current ($t_p < 5 \text{ ms}$)	12	A
I_B	Base Current	5	A
I_{BM}	Base Peak Current ($t_p < 5 \text{ ms}$)	8	A
P_{tot}	Total Dissipation at $T_c = 25^\circ\text{C}$	72	W
T_{stg}	Storage Temperature	-65 to 150	$^\circ\text{C}$
T_j	Max. Operating Junction Temperature	150	$^\circ\text{C}$

THERMAL DATA

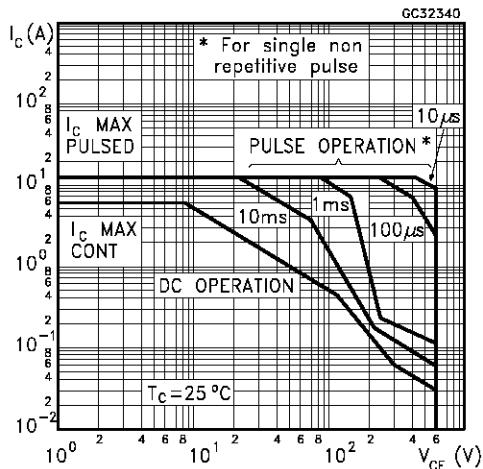
$R_{thj-case}$	Thermal Resistance Junction-case	Max	1.72	$^{\circ}\text{C/W}$
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ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{\circ}\text{C}$ unless otherwise specified)

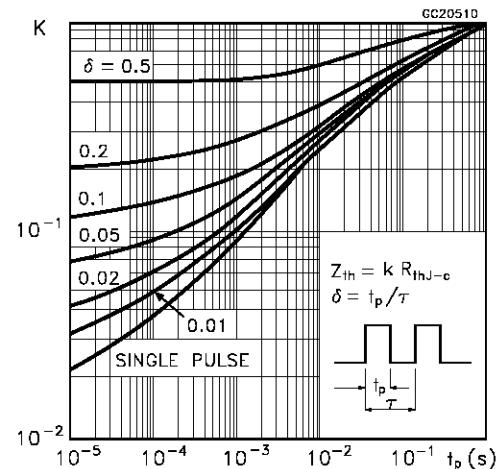
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cut-off Current ($V_{BE} = 0$)	$V_{CE} = 1200 \text{ V}$			200	μA
I_{CEO}	Collector Cut-off Current ($I_B = 0$)	$V_{EC} = 380 \text{ V}$ $V_{EC} = 600 \text{ V}$			200 2	μA mA
I_{EBO}	Emitter Cut-off Current ($I_C = 0$)	$V_{BE} = 7 \text{ V}$			1	mA
$V_{CEO(sus)*}$	Collector-Emitter Sustaining Voltage	$I_C = 100 \text{ mA}$	600			V
$V_{CE(sat)*}$	Collector-Emitter Saturation Voltage	$I_C = 3.5 \text{ A} \quad I_B = 0.7 \text{ A}$ $I_C = 2.5 \text{ A} \quad I_B = 0.35 \text{ A}$			1.5 1.5	V V
$V_{BE(sat)*}$	Base-Emitter Saturation Voltage	$I_C = 3.5 \text{ A} \quad I_B = 0.7 \text{ A}$ $I_C = 2.5 \text{ A} \quad I_B = 0.35 \text{ A}$			1.5 1.5	V V
t_{ON} t_s t_f	Turn-on Time Storage Time Fall Time	RESISTIVE LOAD $V_{CC} = 250 \text{ v} \quad I_C = 3.5 \text{ A}$ $I_{B1} = 0.7 \text{ A} \quad I_{B1} = -1.4 \text{ A}$		0.7 2.2 0.18	1.2 3.5 0.4	μs μs μs
t_{ON} t_s t_f	Turn-on Time Storage Time Fall Time	RESISTIVE LOAD $V_{CC} = 250 \text{ v} \quad I_C = 3.5 \text{ A}$ $I_{B1} = 0.7 \text{ A} \quad I_{B1} = -1.4 \text{ A}$ With Antisaturation Network		0.7 1.5 0.2		μs μs μs
t_{ON} t_s t_f	Turn-on Time Storage Time Fall Time	RESISTIVE LOAD $V_{CC} = 250 \text{ V} \quad I_C = 3.5 \text{ A}$ $I_{B1} = 0.7 \text{ A} \quad V_{BE(\text{off})} = -5 \text{ V}$		0.7 1 0.2		μs μs μs
t_s t_f	Storage Time Fall Time	INDUCTIVE LOAD $I_C = 3.5 \text{ A} \quad h_{FE} = 5$ $V_{CL} = 450 \text{ V} \quad V_{BE(\text{off})} = -5 \text{ V}$ $L = 300 \mu\text{H} \quad R_{BB} = 1.2 \Omega$		1.4 0.1	2.8 0.2	μs μs
t_s t_f	Storage Time Fall Time	INDUCTIVE LOAD $I_C = 3.5 \text{ A} \quad h_{FE} = 5$ $V_{CL} = 450 \text{ V} \quad V_{BE(\text{off})} = -5 \text{ V}$ $L = 300 \mu\text{H} \quad R_{BB} = 1.2 \Omega$ $T_c = 100 \ ^{\circ}\text{C}$			4 0.3	μs μs

* Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %

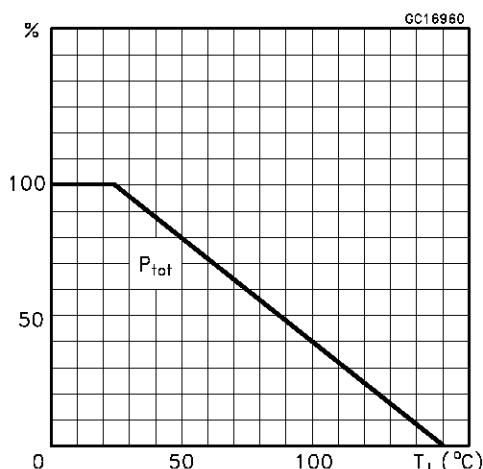
Safe Operating Area



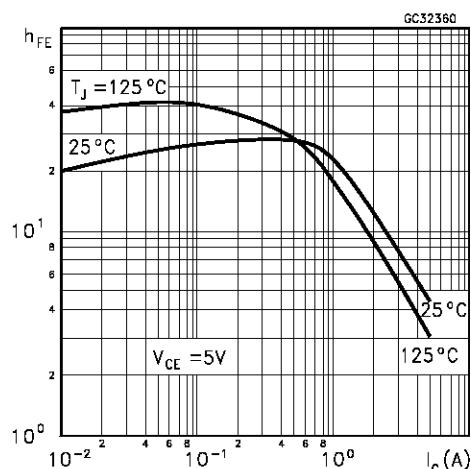
Thermal Impedance



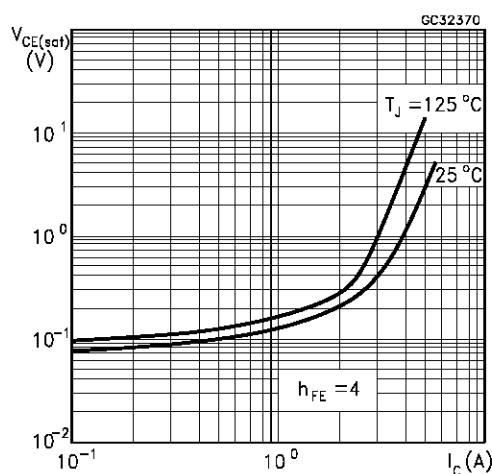
Derating Curve



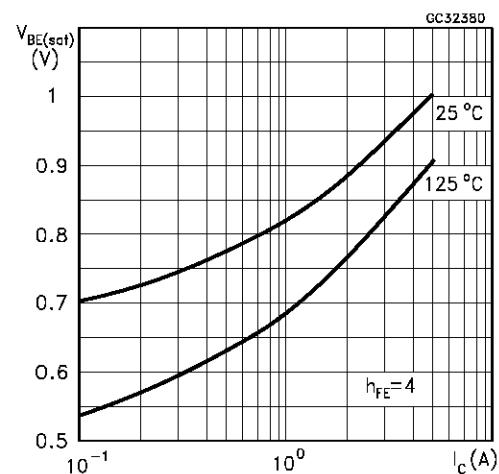
DC Current Gain



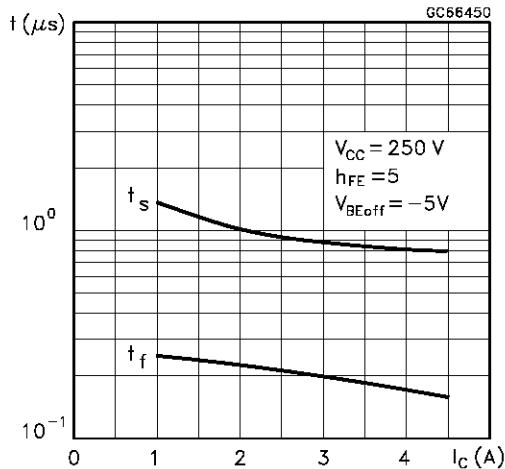
Collector Emitter Saturation Voltage



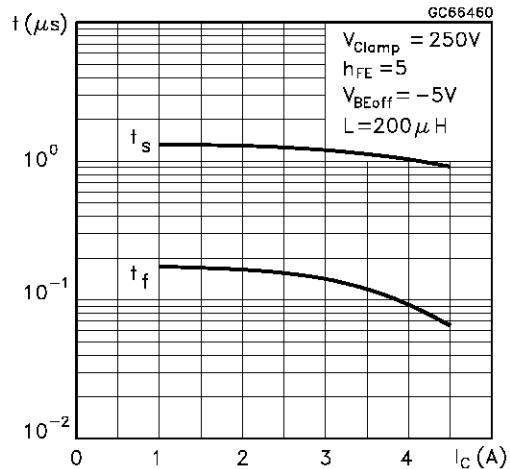
Base Emitter Saturation Voltage



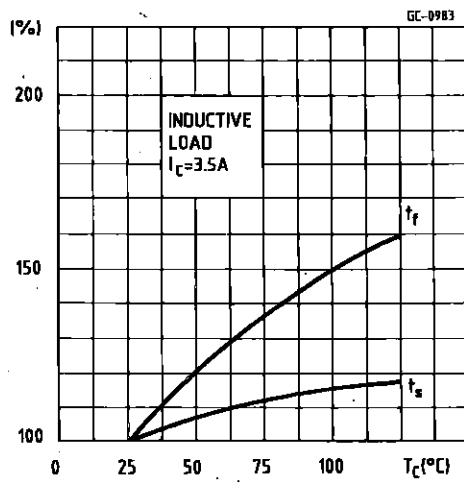
Resistive Load Switching Times



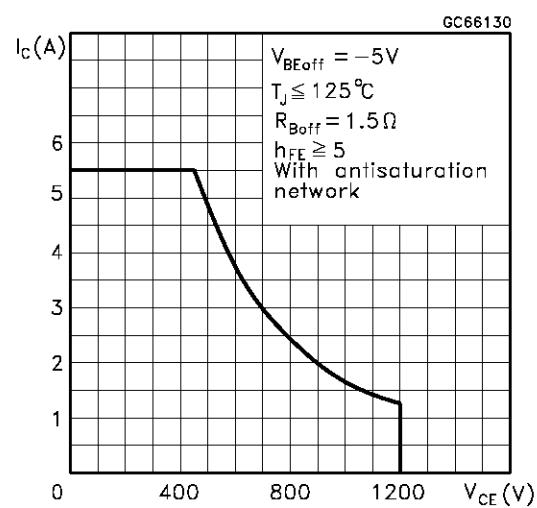
Inductive Load Switching Times



Switching Times Percentage Variation

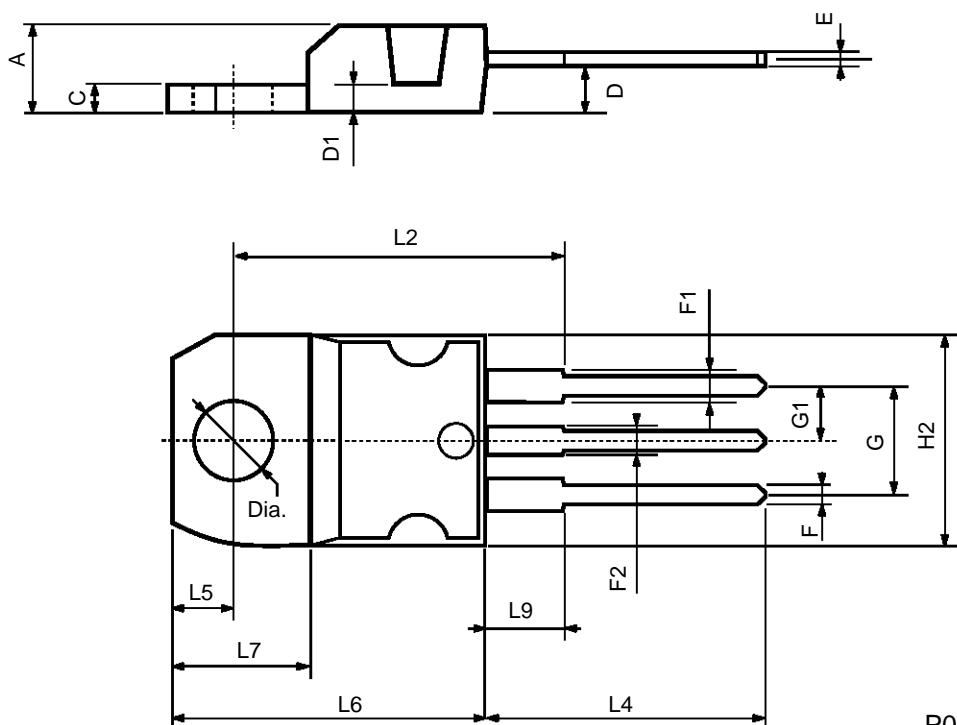


Reverse Biased SOA



TO-220 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
C	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



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